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## V850E2/ML4

R01AN1223JJ0100

### DMA Control

Rev.1.00

Jun. 22, 2012

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#### Abstract

This document describes how to set up the DMA (Direct Memory Access) and also gives an outline of the operation and describes the procedures for using a sample program.

The features of the operation are described below:

Transfer inside of inner RAM.

Transfer between inner RAM and peripheral I/O.

DMAC (Direct Memory Access Controller) transfers by software trigger.

DTFR (DMA trigger factor register) transfers by interrupt signal trigger.

#### Products

V850E2/ML4

#### Integrated development environments

CubeSuite+, GHS MULTI V5.1.7D, and IAR for V850 Kickstart V3.80.

When using this application note with other Renesas MCUs, careful evaluation is recommended after making modifications to comply with the alternate MCU.

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### 1. Specifications

This application note explains examples using DMAC (Direct Memory Access Controller) and DTFR (DMA Trigger Factor Register).

Table 1.1 lists the Peripheral Functions and their Applications and Figure1.1 shows the Example1: transfer inside of inner RAM by DMAC.

Table 1.1 Peripheral Functions and their Applications

Peripheral Function	Application
Ports(P1_4, P1_5, P4_3, P4_4)	Connected to LEDs, and light on or off LEDs.
Ports(P0_0..P0_15)	Destination of DTFR transfer.

The parameters required for the transfer of data are stored in the DMAC, which transfers data in response to DMA transfer requests. As an example of software DMA transfer requests, the main points in the operation of the software to transfer data between locations in internal memory are illustrated below.

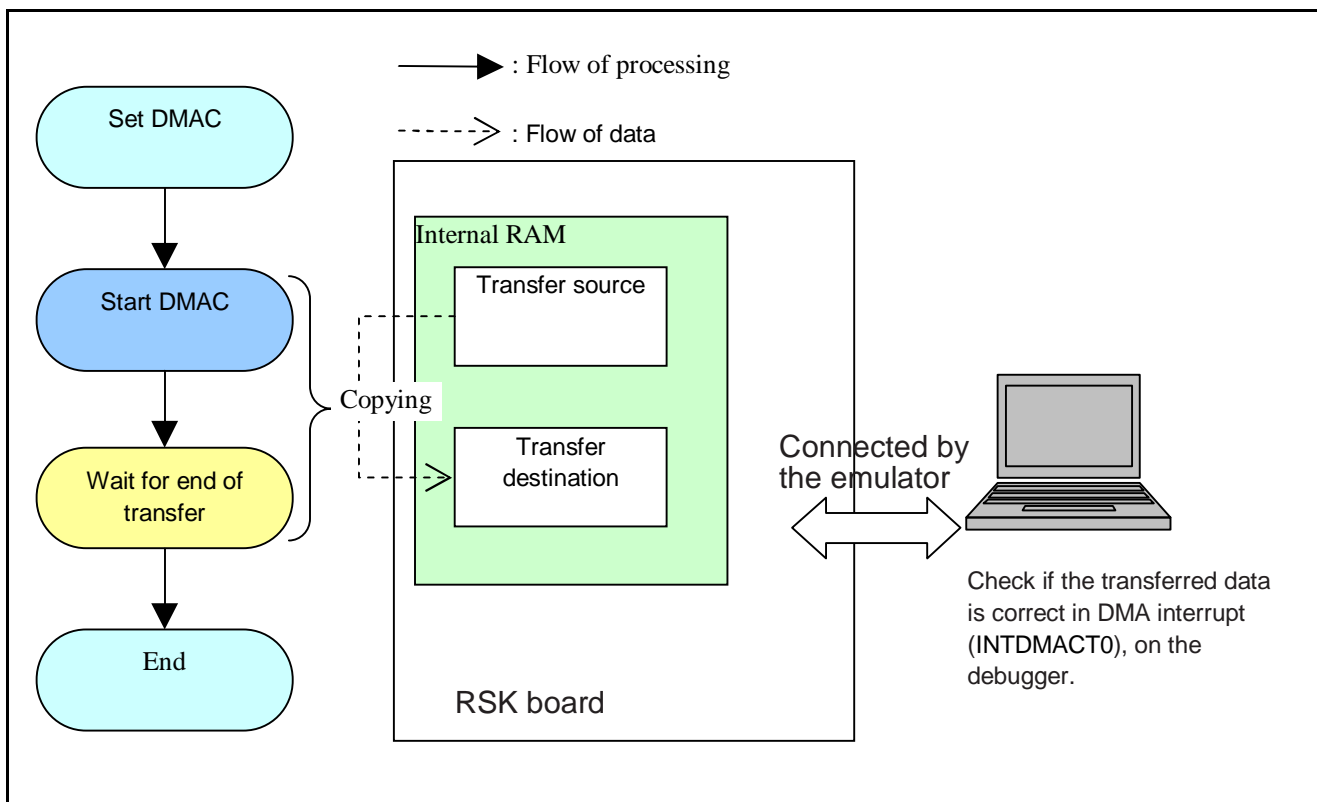


Figure1.1 Example1: transfer inside of inner RAM by DMAC

<sup>1</sup> Mass production of RSK board will start in August, 2012.

The DTFR (DMA Trigger Factor Register) is used to select the interrupt signal which becomes the trigger for DMA from among all interrupt signals. Requests from the DTFR for the DMA transfer of data are handled by the DMAC.

Specifically, the signal to be used as a DMA transfer request is selected from among the 128 input interrupt signals by the setting in DTFRn (n = 15 to 0). As an example of a hardware DMA transfer request, the main points in transferring data with a timer interrupt as the trigger are illustrated below. The data from internal RAM are output via port P0.

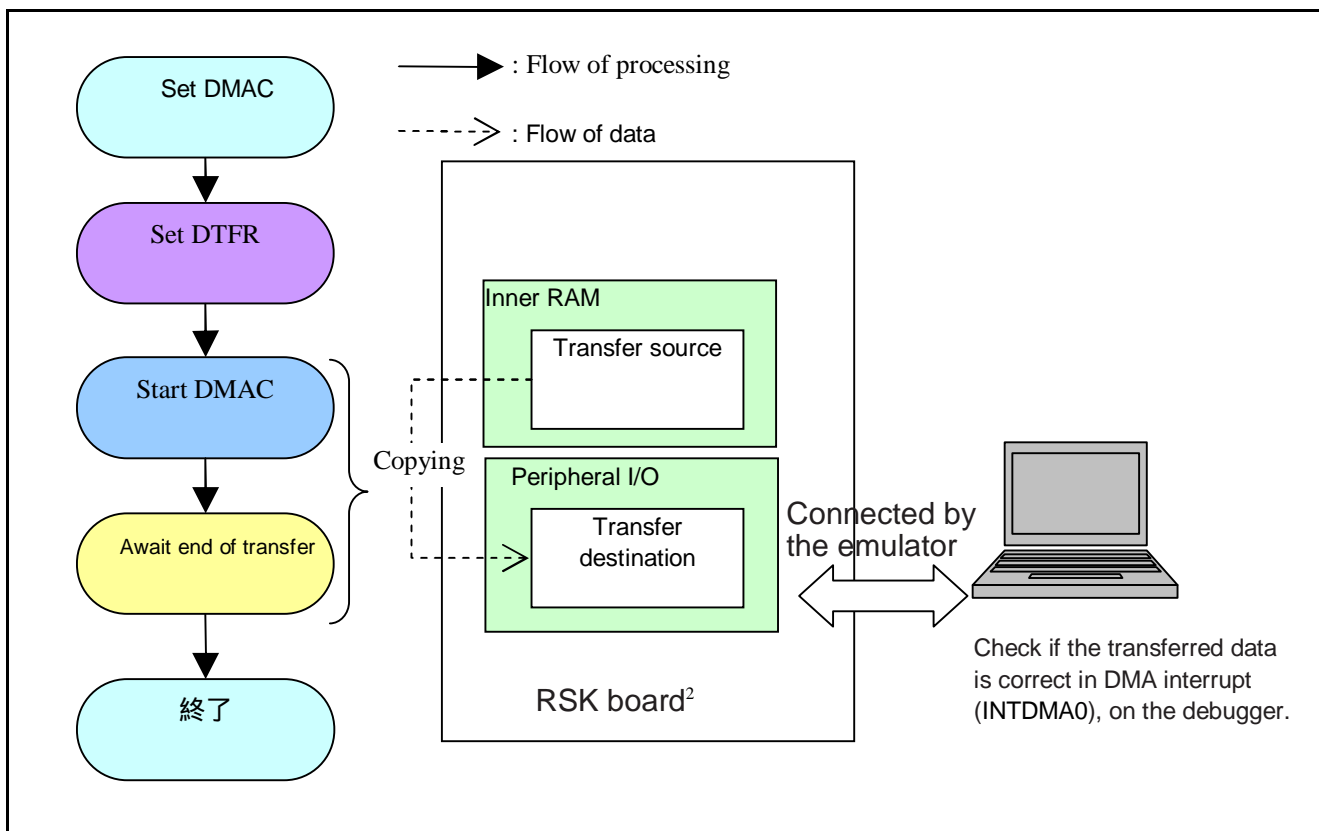


Figure 1.2 Example2: transfer between inner RAM and peripheral I/O by DTFR

<sup>2</sup> Mass production of RSK board will start in August, 2012.

## 2. Operation Confirmation Conditions

The sample code accompanying this application note has been run and confirmed under the conditions below.

Table 2.1 Operation Confirmation Conditions

Item	Contents
MCU used	V850E2/ML4
Operating frequency	200MHz (PLL multiplies the oscillator input frequency (fx: 10MHz) by 20.)
Operating voltage	3.3V
Integrated development environment	CubeSuite+ V1.00
	GHS MULTI V5.1.7D
	IAR for V850 Kickstart V3.80.1
C compiler	CX V1.20(CubeSuite+), optimization: default
	C-V850E 5.1.7 RELEASE(GHS MULTI) , optimization: default
	IAR C/C++ Compiler for V850 3.80.1 [Kickstart] (3.80.1.30078), optimization: default
Operating mode	Normal operation mode
Sample code version	V1.00
Board used	RSK board
Device used	E1 emulator or MINICUBE
Tool used	none

## 2.1 Pin(s) Used

Table 2.2 lists the Pins Used and Its Function.

**Table 2.2 Pins Used and Its Functions**

Pin Name	I/O	Function
PORT P1_4	output	Port mode, output, LED0
PORT P1_5	output	Port mode, output, LED1
PORT P4_3	output	Port mode, output, LED2
PORT P4_4	output	Port mode, output, LED3
PORT P0_0..P0_15	output	The destination of DTFR transfer

### 3. Software

#### 3.1 Operation Overview

Operation Overview is described in the following figure. The main() function initializes each functions, and waits interrupt. When DMA transfer completion or transfer count match interrupt has occurred, this sample lights on or off LED, or clears transfer completion flag.

Figure3.1 shows the Sequence.

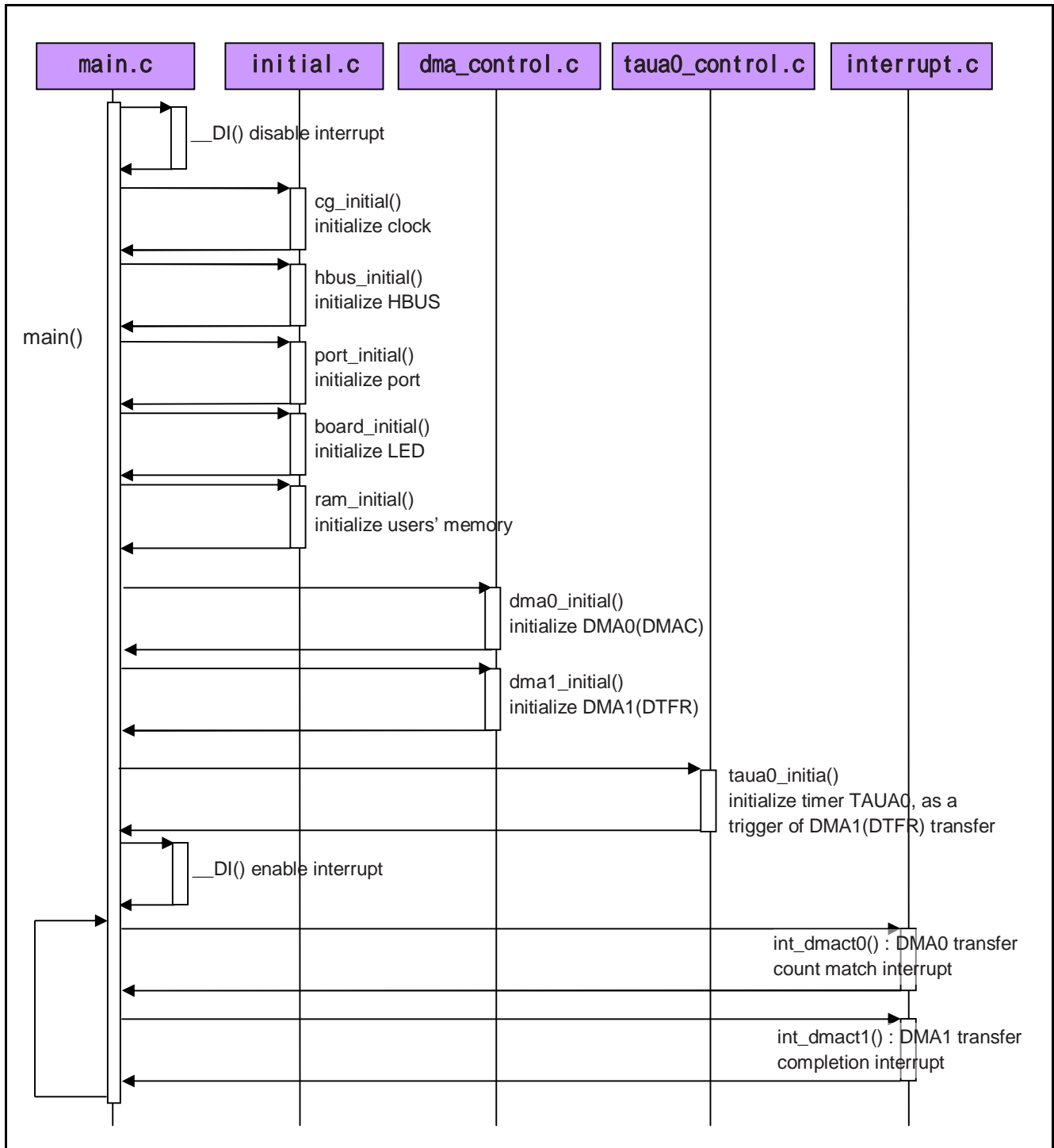


Figure3.1 Sequence diagram

### 3.2 Required Memory Size

Table 3.1 lists the Required Memory Size. (CubeSuite+, optimization=default)

Table 3.1 Required Memory Size

Memory Used	Size	Remarks
ROM	5100	Shown as ROM area size in map file
RAM	4108	Shown as RAM area size in map file
Maximum user stack usage	4	CubeSuite+ stack estimation tool calculated.
Maximum interrupt stack usage	60	The same as above.

Note: The required memory size varies depending on the C compiler version and its options.



### 3.3 File Composition

Table 3.2 lists the File(s) Used in the Sample Code. Files not generated by the integrated development environment should not be listed in this table.

Table 3.2 File(s) Used in the Sample Code

File Name	Outline	Remarks
crtE.s	Initialize hardware	Only in the project for CubeSuite+
startup.s		Only in the project for GHS MULTI
V850E2ML4.dir	Linker directive file	Only in the project for CubeSuite+
V850E2_ML4 DMA.Id		Only in the project for GHS MULTI
vector.s	Vector table	Only in the project for GHS MULTI
dma.h	Declare variables and functions.	
df4022_800.h	Declare register macros for V850E2/ML4	Only in the project for GHS MULTI
main.c	Main routine	
initial.c	Initialize software	
dma_control.c	Initialize DMA	
taua0_control.c	Initialize timer TAU0	
interrupt.c	Interrupt routines	

### 3.4 Option-Setting Memory

This sample does not specify any option-bytes. Specify them if necessary.

### 3.5 Function(s)

Table 3.3 lists the Function(s).

Table 3.3 Function(s)

Function Name	Outline
void port_initial(void)	Sets up ports and their mode.
void cg_initial(void)	Initializes the special clock frequency control register.
void hbus_initial(void)	Initializes the AHB bus
void board_initial(void)	Initializes the LEDs
void ram_initial(void)	Sets up the initial state of the user RAM
void dma0_initial(void)	Initializes DMA0(DMAC)
void dma1_initial(void)	Initializes DMA1(DTFR)
void taua0_initial(void)	Initialize timer TAU0 as a trigger of DTFR
interrupt void int_dmact0(void)	DMA0 transfer count match interrupt.
interrupt void int_dma1(void)	DMA1 transfer completion interrupt.
void main(void)	Calls necessary initialization functions and waits interrupt in infinite loop.

### 3.6 Function Specification(s)

The following tables list the sample code function specification(s).

main()	
<b>Outline</b>	Main routine
<b>Header</b>	-
<b>Declaration</b>	void main(void)
<b>Description</b>	Calls necessary initialization functions and waits interrupt in infinite loop.
<b>Arguments</b>	-
<b>Return Value</b>	-
port_initial()	
<b>Outline</b>	Sets up ports and their mode.
<b>Header</b>	csih.h
<b>Declaration</b>	void port_initial (void)
<b>Description</b>	Sets up ports in port-mode, output, for controlling LEDs.
<b>Arguments</b>	none
<b>Return Value</b>	none
cg_initial()	
<b>Outline</b>	Initialize clock
<b>Header</b>	csih.h
<b>Declaration</b>	void cg_initial(void)
<b>Description</b>	Initializes the special clock frequency control register.
<b>Arguments</b>	none
<b>Return Value</b>	none
hbus_initial()	
<b>Outline</b>	Initialize H-bus
<b>Header</b>	csih.h
<b>Declaration</b>	void hbus_initial(void)
<b>Description</b>	Initializes AHB-bus
<b>Arguments</b>	none
<b>Return Value</b>	none
board_initial()	
<b>Outline</b>	Initialize board
<b>Header</b>	csih.h
<b>Declaration</b>	void board_initial(void)
<b>Description</b>	Initialize LED on the board.
<b>Arguments</b>	-
<b>Return Value</b>	-

<b>ram_initial()</b>	
<b>Outline</b>	Initialize users' memory.
<b>Header</b>	csih.h
<b>Declaration</b>	void ram_initial(void)
<b>Description</b>	Initialize LED on the board.
<b>Arguments</b>	-
<b>Return Value</b>	-
<b>dma0_initial()</b>	
<b>Outline</b>	Initialize DMA0
<b>Header</b>	dma.h
<b>Declaration</b>	void dma0_initial(void)
<b>Description</b>	Initialize DMA0 as software-triggered DMAC.
<b>Arguments</b>	-
<b>Return Value</b>	-
<b>dma1_initial()</b>	
<b>Outline</b>	Initialize DMA1
<b>Header</b>	dma.h
<b>Declaration</b>	void dma1_initial(void)
<b>Description</b>	Initialize DMA0 as hardware-triggered DTFR.
<b>Arguments</b>	-
<b>Return Value</b>	-
<b>taua0_initial ()</b>	
<b>Outline</b>	Initialize timer TAU0
<b>Header</b>	dma.h
<b>Declaration</b>	void taua0_initial(void)
<b>Description</b>	Initialize TAU0 as a trigger of DTFR.
<b>Arguments</b>	-
<b>Return Value</b>	-
<b>int_dmact0()</b>	
<b>Outline</b>	DMA0 transfer count match interrupt
<b>Header</b>	-
<b>Declaration</b>	__interrupt void int_dmact0(void)
<b>Description</b>	DMA0 transfer count match interrupt, inverts LED.
<b>Arguments</b>	-
<b>Return Value</b>	-
<b>int_dma1()</b>	
<b>Outline</b>	DMA1 transfer completion interrupt
<b>Header</b>	-
<b>Declaration</b>	__interrupt void int_dma1(void)
<b>Description</b>	DMA1 transfer completion interrupt, inverts LED, and clears transfer completion flag.
<b>Arguments</b>	-
<b>Return Value</b>	-

### 3.7 Flowchart(s)

#### 3.7.1 Main Processing

Figure3.2 shows the Main Processing.

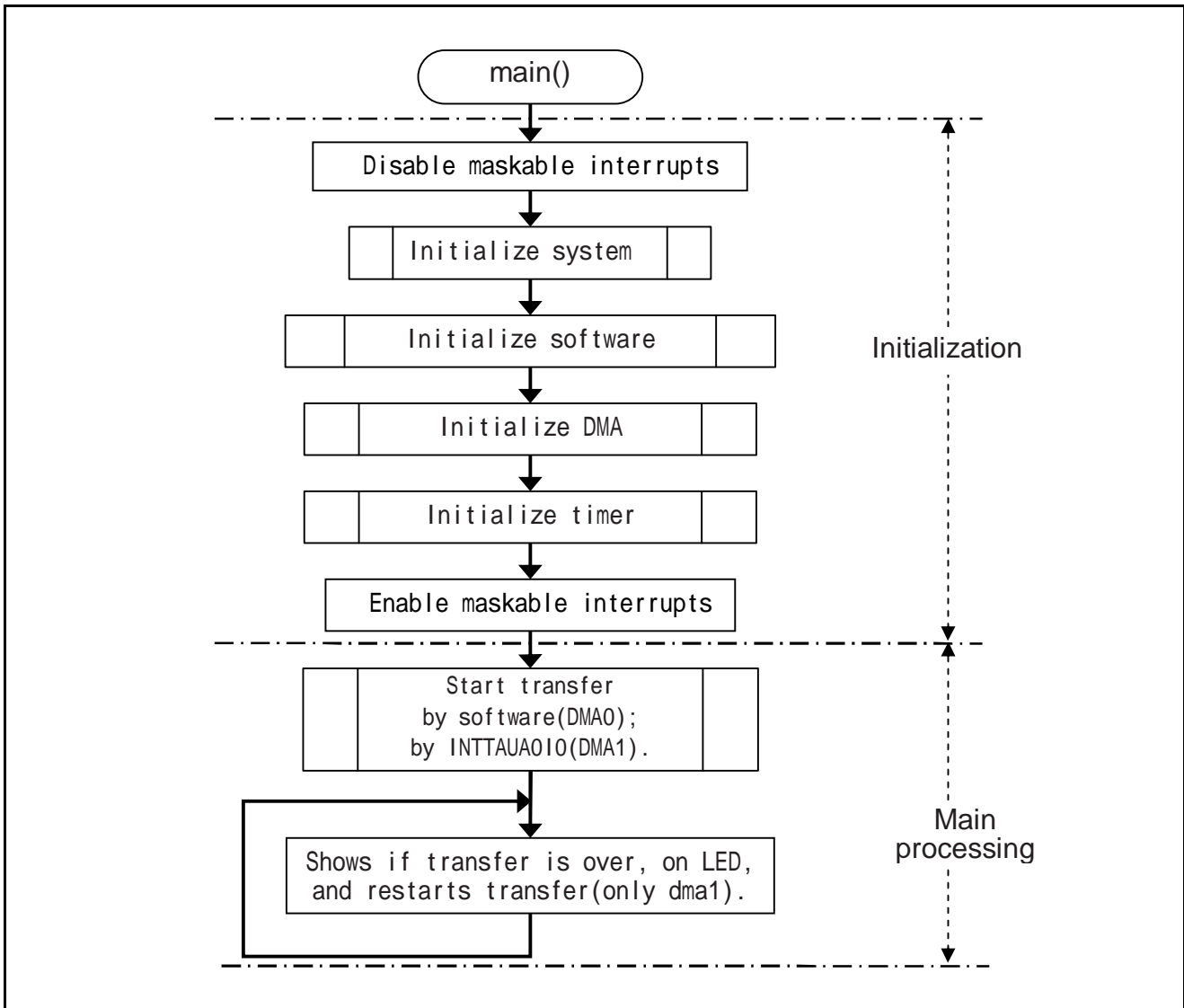


Figure3.2 Main Processing

## 3.7.2 Initialize DMA

Figure3.3 shows flowchart of Initialize DMA0(DMAC).

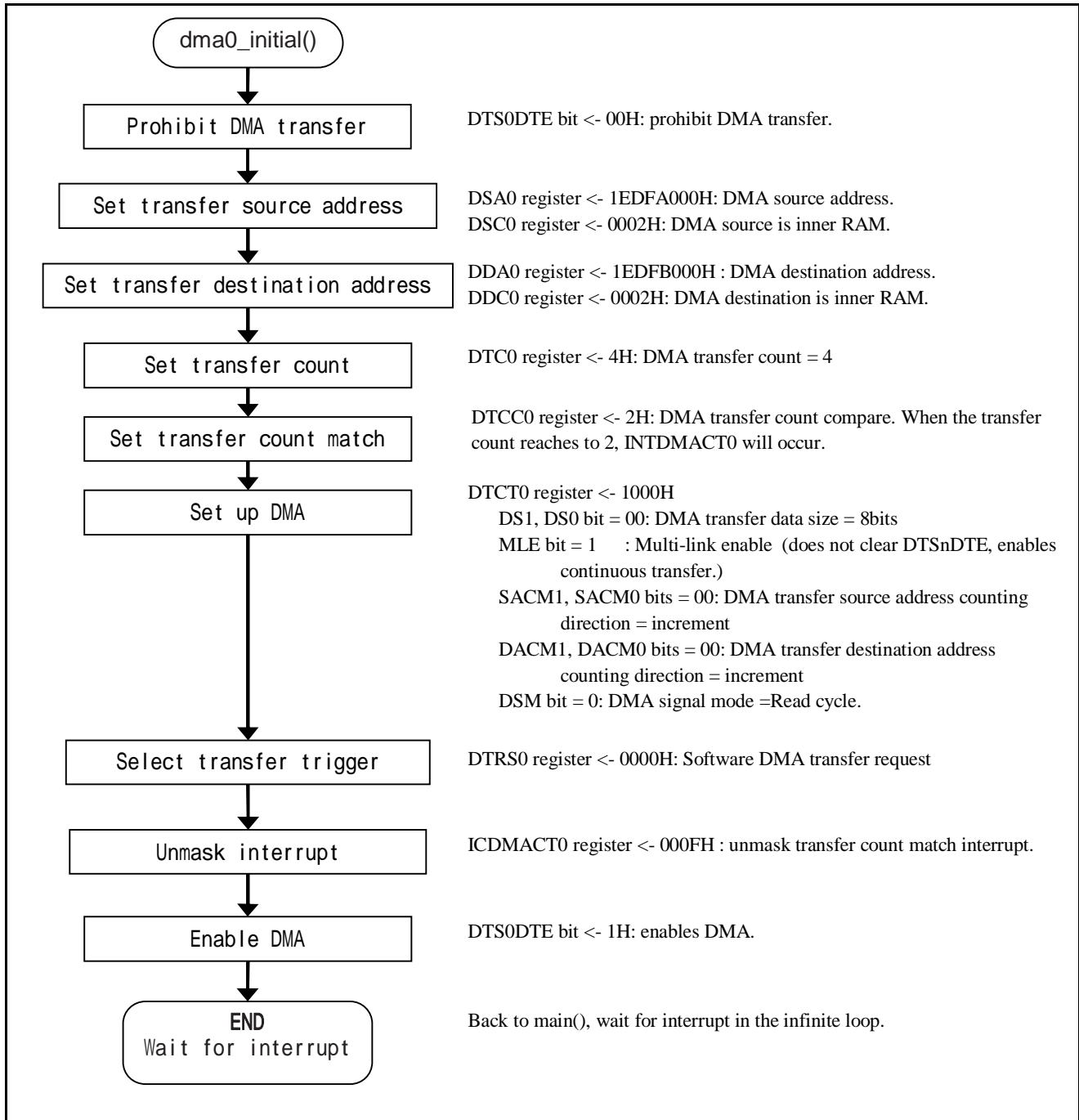


Figure3.3 Initialize DMA0(DMAC)

Figure3.4 shows flowchart of Initialize DMA1(DTFR).

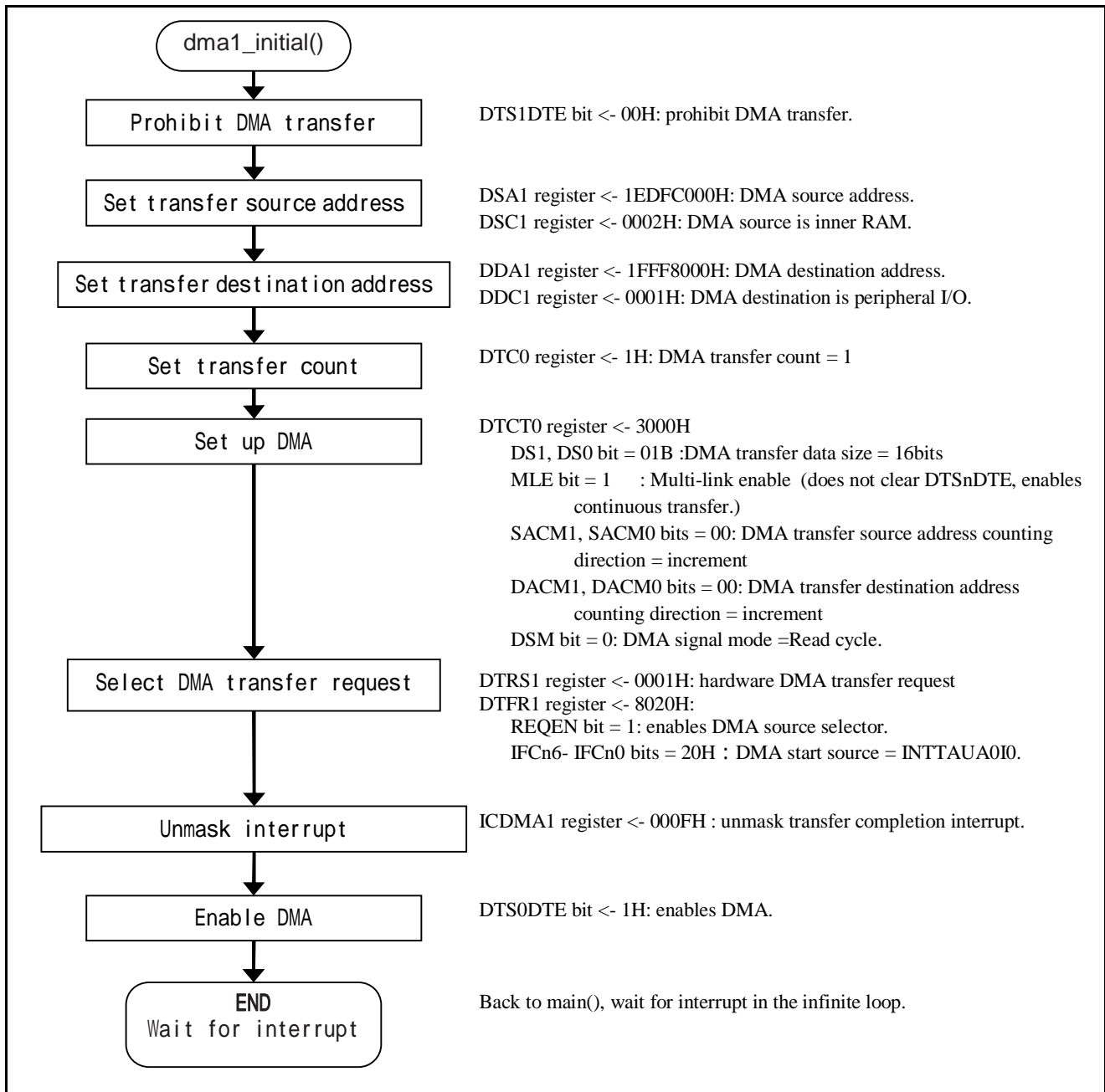


Figure3.4 Initialize DMA1(DTFR)



### 3.7.3 Interrupt Processing

Figure3.5 shows the flowchart of Transfer count match interrupt.

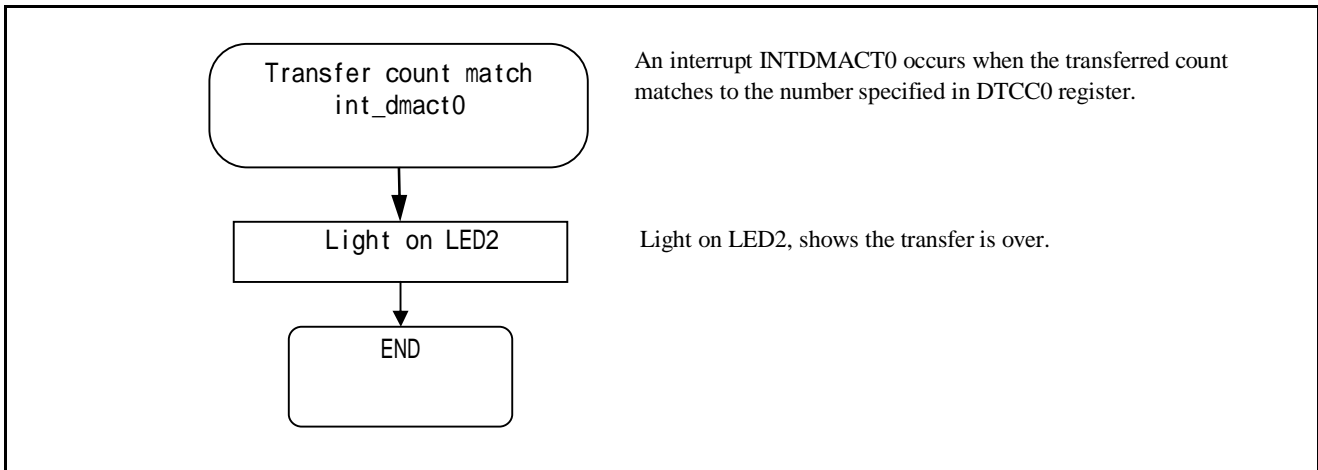


Figure3.5 Transfer count match interrupt

Figure3.6 shows the flowchart of Transfer completion interrupt.

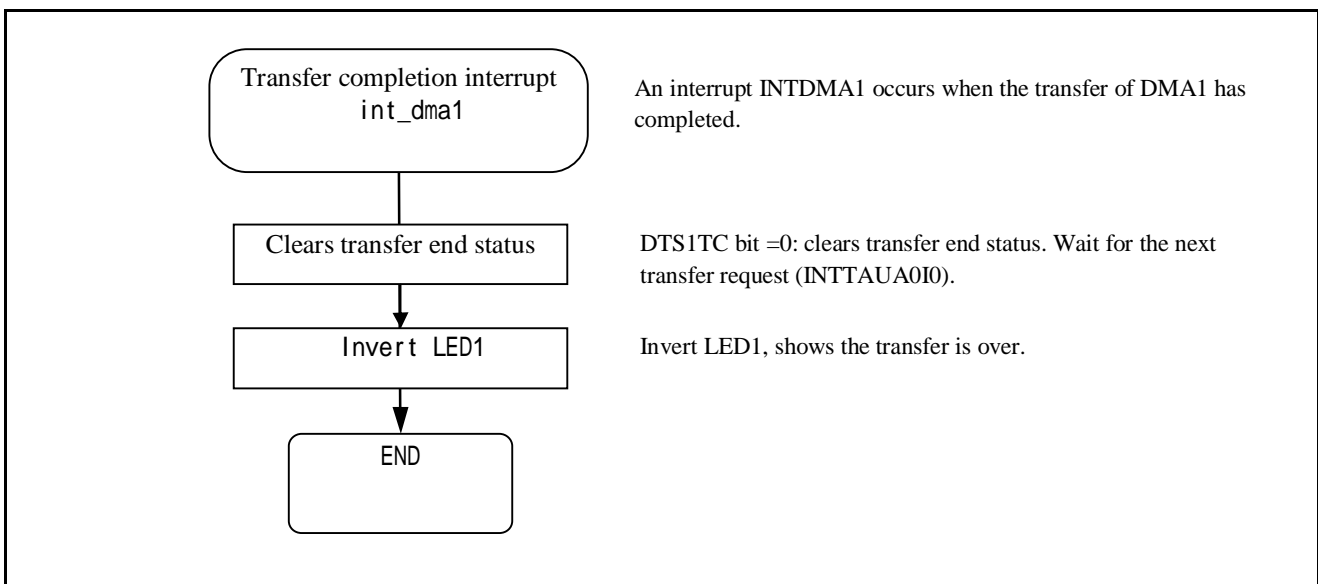


Figure3.6 Transfer completion interrupt

#### 4. Sample Code

Sample code can be downloaded from the Renesas Electronics website.

#### 5. Reference Documents

User's Manual: Hardware

V850E2/ML4 User's Manual: Hardware (R01UH0262EJ)

The latest version can be downloaded from the Renesas Electronics website.

Technical Update/Technical News

The latest information can be downloaded from the Renesas Electronics website.

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REVISION HISTORY	V850E2/ML4 Application Note DMA Controller
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		Page	Summary
1.00	Jun. 22, 2012	—	First edition issued

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## General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this manual, refer to the relevant sections of the manual. If the descriptions under General Precautions in the Handling of MPU/MCU Products and in the body of the manual differ from each other, the description in the body of the manual takes precedence.

### 1. Handling of Unused Pins

Handle unused pins in accord with the directions given under Handling of Unused Pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

### 2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.

In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed.

In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

### 3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

### 4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

### 5. Differences between Products

Before changing from one product to another, i.e. to one with a different type number, confirm that the change will not lead to problems.

The characteristics of MPU/MCU in the same group but having different type numbers may differ because of the differences in internal memory capacity and layout pattern. When changing to products of different type numbers, implement a system-evaluation test for each of the products.

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